

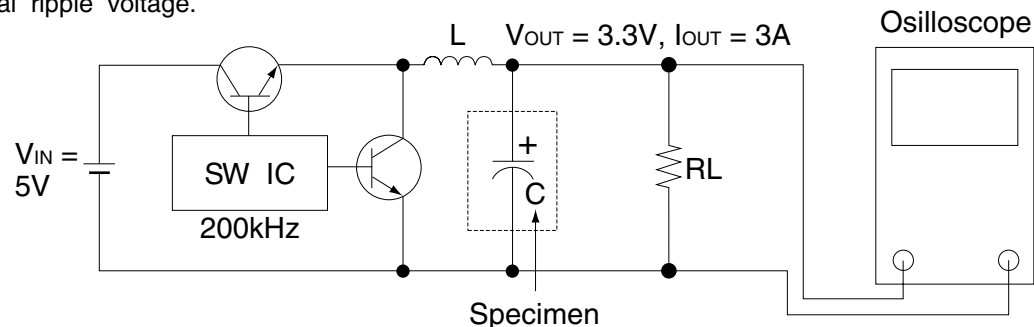
Ripple removal capability of OS-CON

While there is a tendency to downsize switching power supplies, capacitors remain one of the parts occupying large areas of circuit boards. Furthermore, since capacitors vary widely in characteristics with working temperatures in general, selection in consideration of working temperature range is required.

With this being the situation, the ripple removal capability of the OS-CON at high frequencies in a wide range of working temperatures is shown by the following experiment.

Experiment

Using a general chopper switching power supply, the OS-CON, low-impedance aluminum electrolytic capacitors, and low-ESR tantalum capacitors were connected as the capacitor in the output-side smoothing circuit at working temperatures of -20°C , 25°C and 70°C for comparisons of output residual ripple voltage.



Using the OS-CON • $100\mu\text{F}/6.3\text{WV}$ (6SVP100M $\phi 6.3\text{mm} \times 6\text{mm}$) as the output-side smoothing capacitor (C) in the above test circuit, the residual ripple voltage was measured at ambient temperatures of -20°C , 25°C and 70°C .

Next, low-impedance aluminum electrolytic capacitors and low-ESR tantalum capacitors were selected for measurement at each temperature (-20°C , 25°C , and 70°C) so that the residual ripple voltage became equal to that achieved when the OS-CON • $100\mu\text{F}/6.3\text{WV}$ was used.

Finally, the residual ripple voltage was measured at each temperature (-20°C and 70°C) with output-side smoothing capacitors equal in number under the 25°C conditions, and the rates of change in the ESR of the smoothing capacitors were calculated from the amounts of change.

Result

Table1 On-board area ratios of capacitors at each temperature (when the residual ripple voltage is on the same level)

| Ambient temperature | OS-CON | Aluminum Electrolytic capacitor | Tantalum capacitor |
|-----------------------|--------|---------------------------------|--------------------|
| 25°C | 1 | 7.15 | 1.46 |
| -20°C | 1 | 16.7 | 1.46 |
| 70°C | 1 | 4.77 | 1.46 |

Table2 Rates of change in ESR on the basis of 25°C ※

| Ambient temperature | OS-CON | Aluminum Electrolytic capacitor | Tantalum capacitor |
|-----------------------|--------|---------------------------------|--------------------|
| 25°C | 1 | 1 | 1 |
| -20°C | 1.14 | 3.03 | 1.27 |
| 70°C | 0.952 | 0.587 | 0.85 |

$$\text{※Rate of change in ESR} = \frac{\text{Residual ripple voltage at ambient temperature} \times \text{Oscillation frequency at ambient temperature}}{\text{Residual ripple voltage at } 25^{\circ}\text{C} \times \text{Oscillation frequency at } 25^{\circ}\text{C}}$$

From the above results, it can also be understood how the OS-CON excels in temperature characteristics.

IX. Application

Table-1

| Ambient temperature | 25°C | | |
|-------------------------|---------------|---------------------------------|--------------------|
| Capacitor type | OS-CON | Aluminum Electrolytic capacitor | Tantalum capacitor |
| Capacitor capacitance | 100μF/6.3WV | 680μF/6.3WV | 100μF/10WV |
| Quantity | 1pc | 3pcs | 2pcs |
| Residual ripple voltage | 22.8mV | 23.8mV | 24.8mV |
| Size (※2) | 6.6 X 6.6(mm) | 10.5 X 10.5(mm) | 7.5 X 4.5(mm) |
| On-board area ratio | 1 | 7.15 | 1.46 |
| Oscillation frequency | 200kHz | | |
| Fig | Fig1 | Fig4 | Fig9 |

Table-2

| Ambient temperature | - 20°C | | | |
|-------------------------|---------------|---------------------------------|----------|--------------------|
| Capacitor type | OS-CON | Aluminum Electrolytic capacitor | | Tantalum capacitor |
| Capacitor capacitance | 100μF/6.3WV | 680μF/6.3WV | | 100μF/10WV |
| Quantity (※1) | 1pc | 7pcs | (3pcs) | 2pcs |
| Residual ripple voltage | 20.8mV | 24.4mV | (57.6mV) | 25.2mV |
| Size (※2) | 6.6 X 6.6(mm) | 10.5 X 10.5(mm) | | 7.5 X 4.5(mm) |
| On-board area ratio | 1 | 16.7 | | 1.46 |
| Oscillation frequency | 250kHz | | | |
| Fig | Fig2 | Fig5 | Fig6 | Fig10 |





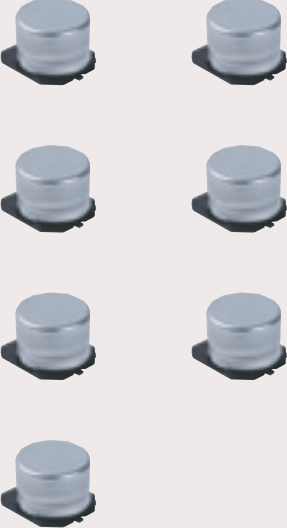




Table-3

| Ambient temperature | 70°C | | | |
|-------------------------|---------------|---------------------------------|----------|--------------------|
| Capacitor type | OS-CON | Aluminum Electrolytic capacitor | | Tantalum capacitor |
| Capacitor capacitance | 100μF/6.3WV | 680μF/6.3WV | | 100μF/10WV |
| Quantity (※1) | 1pc | 2pcs | (3pcs) | 2pcs |
| Residual ripple voltage | 25.6mV | 24.0mV | (16.4mV) | 24.8mV |
| Size (※2) | 6.6 X 6.6(mm) | 10.5 X 10.5(mm) | | 7.5 X 4.5(mm) |
| On-board area ratio | 1 | 4.77 | | 1.46 |
| Oscillation frequency | 170kHz | | | |
| Fig | Fig3 | Fig7 | Fig8 | Fig11 |

※1) Figures in brackets are conditions at 25°C.

※2) For items other than Ta, rather than the element diameter, the base plate dimensions were taken as the maximum dimensions.

IX. Application

| Circumference temperature | OS-CON | Aluminum Electrolytic capacitor | Tantalum capacitor |
|---------------------------|---|---|---|
| 25°C |  |  |  |
| -20°C |  |  |  |
| 70°C |  |  |  |

Application

OS-CON 100 μ F/6.3WV

Fig 1 25°C

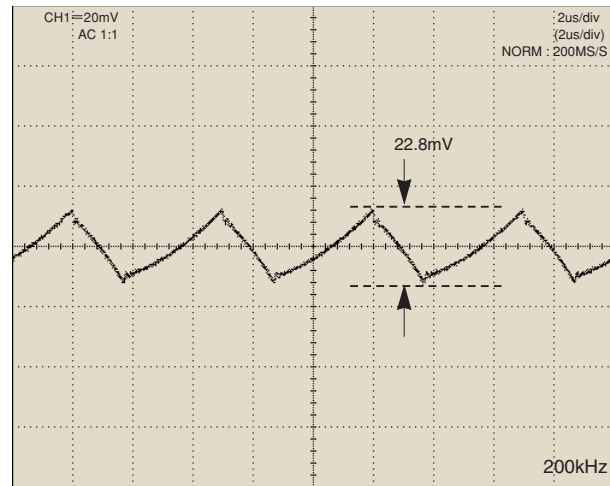


Fig 2 -20°C

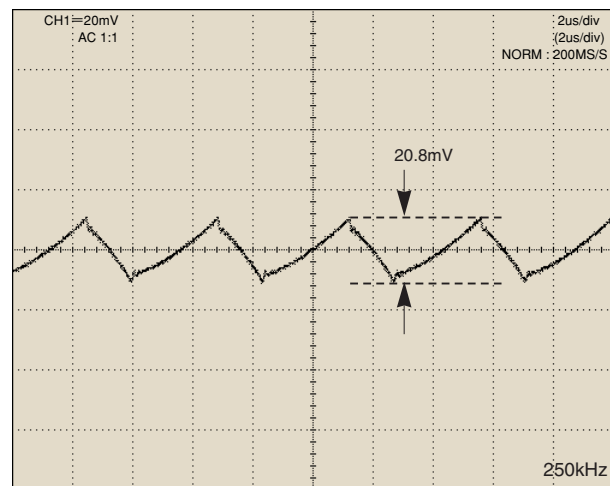
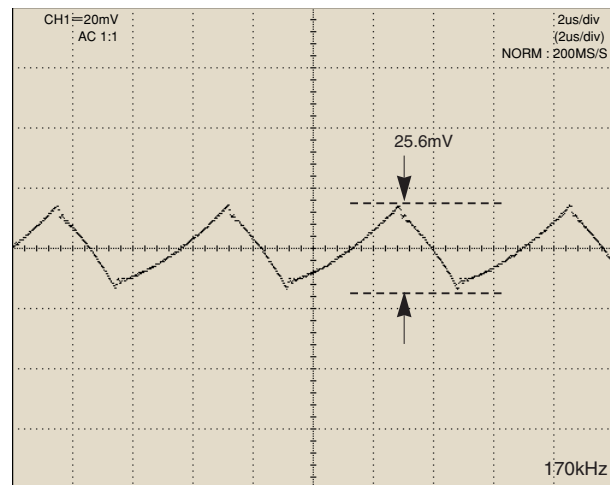


Fig 3 70°C



IX. Application

Low-impedance aluminum electrolytic capacitor 680 μ F/6.3WV

Fig 4 25°C (3pcs)

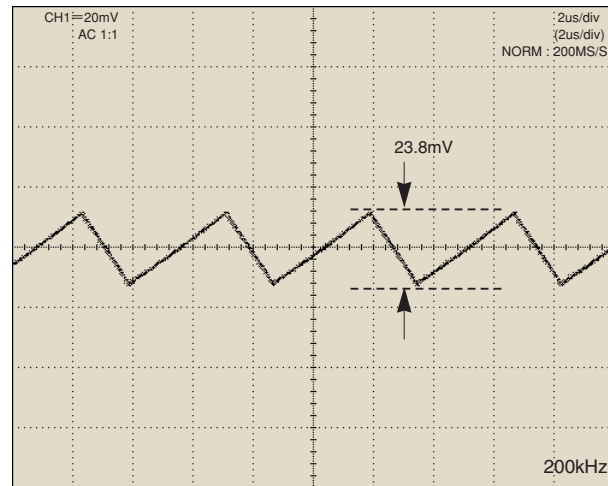


Fig 5 -20°C (7pcs)

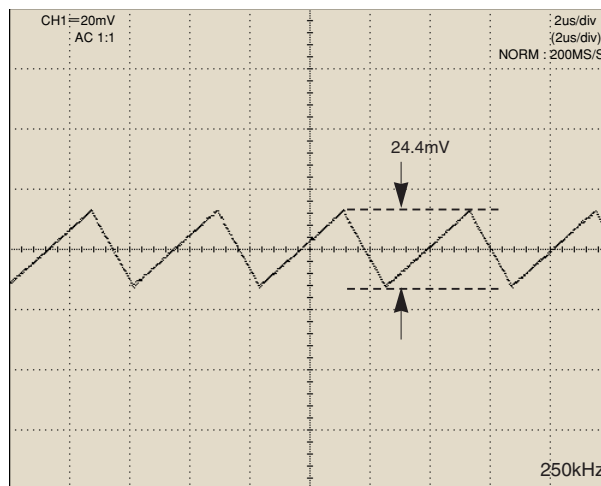


Fig 6 -20°C (3pcs)

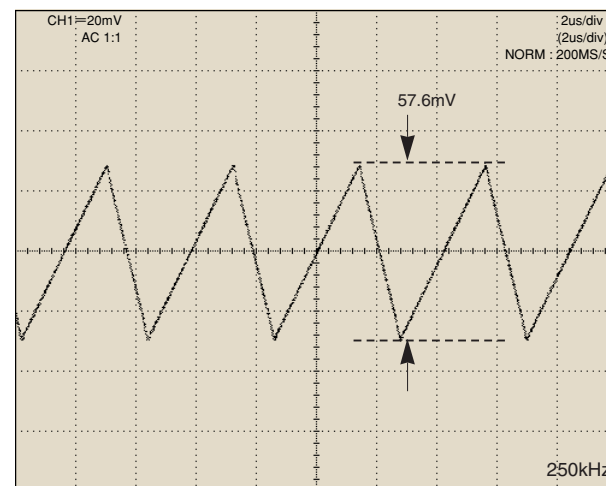


Fig 7 70°C (2pcs)

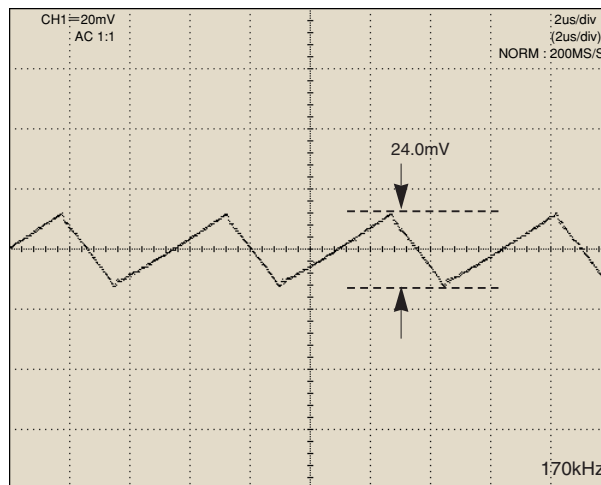
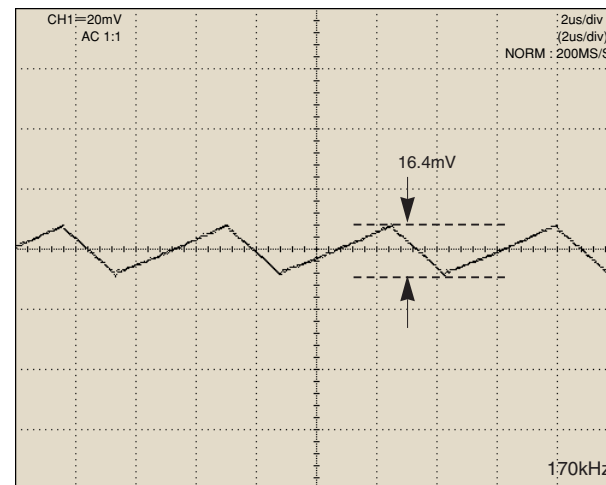


Fig 8 70°C (3pcs)



Low-ESR Tantalum capacitor 220 μ F/10WV

Fig 9 25°C (2pcs)

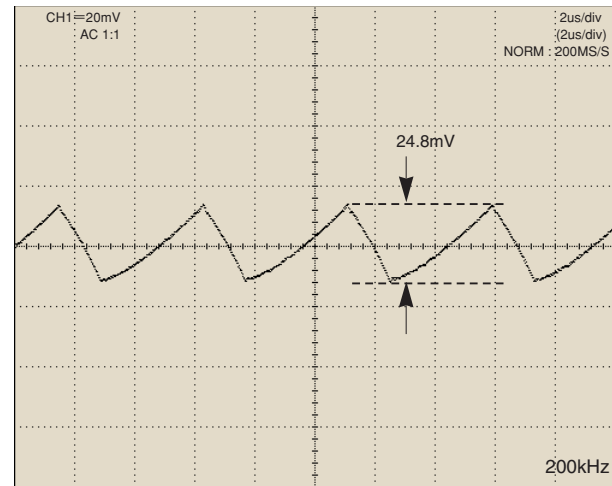


Fig 10 -20°C (2pcs)

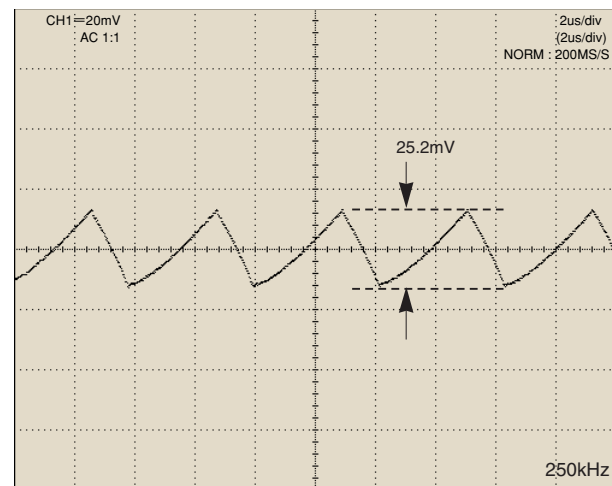


Fig 11 70°C (2pcs)

